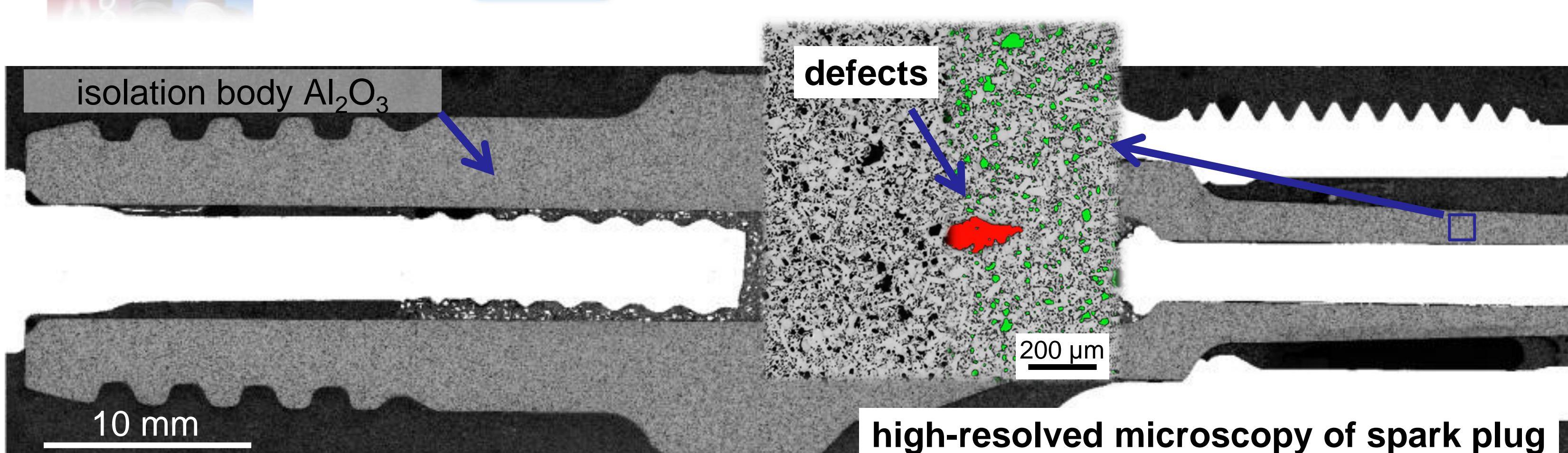
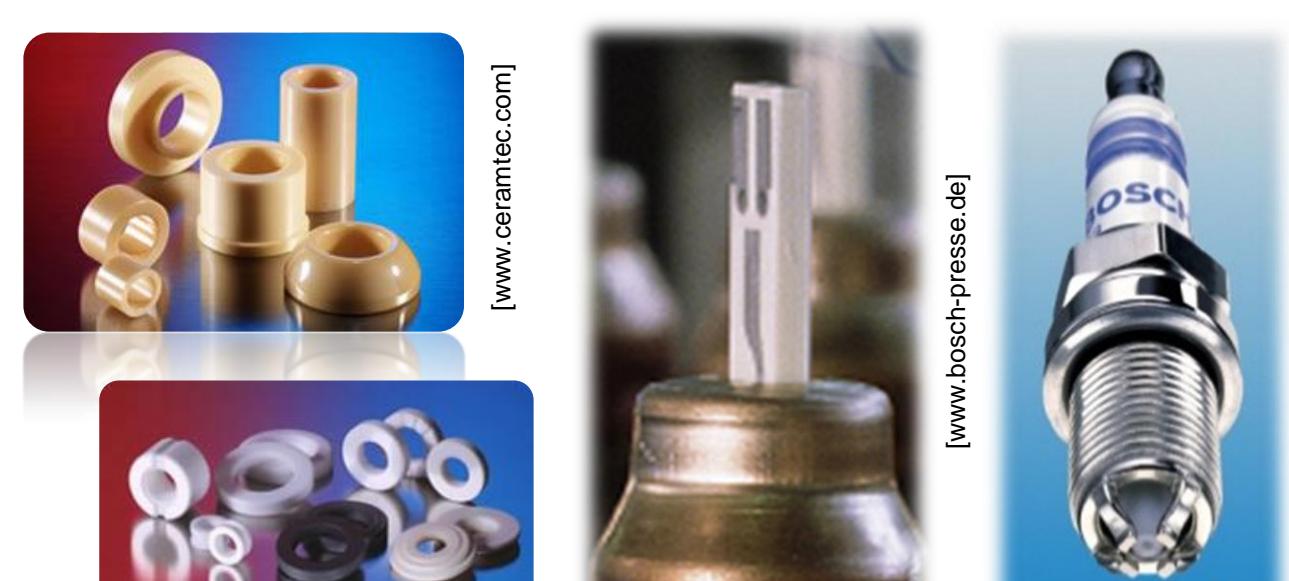


Prediction of Mechanical Properties of Ceramics using Quantitative Microstructure Analysis

T. Bernthaler, A. Nagel, G. Schneider, V. Knoblauch, M. Hoffman

Motivation and advantage

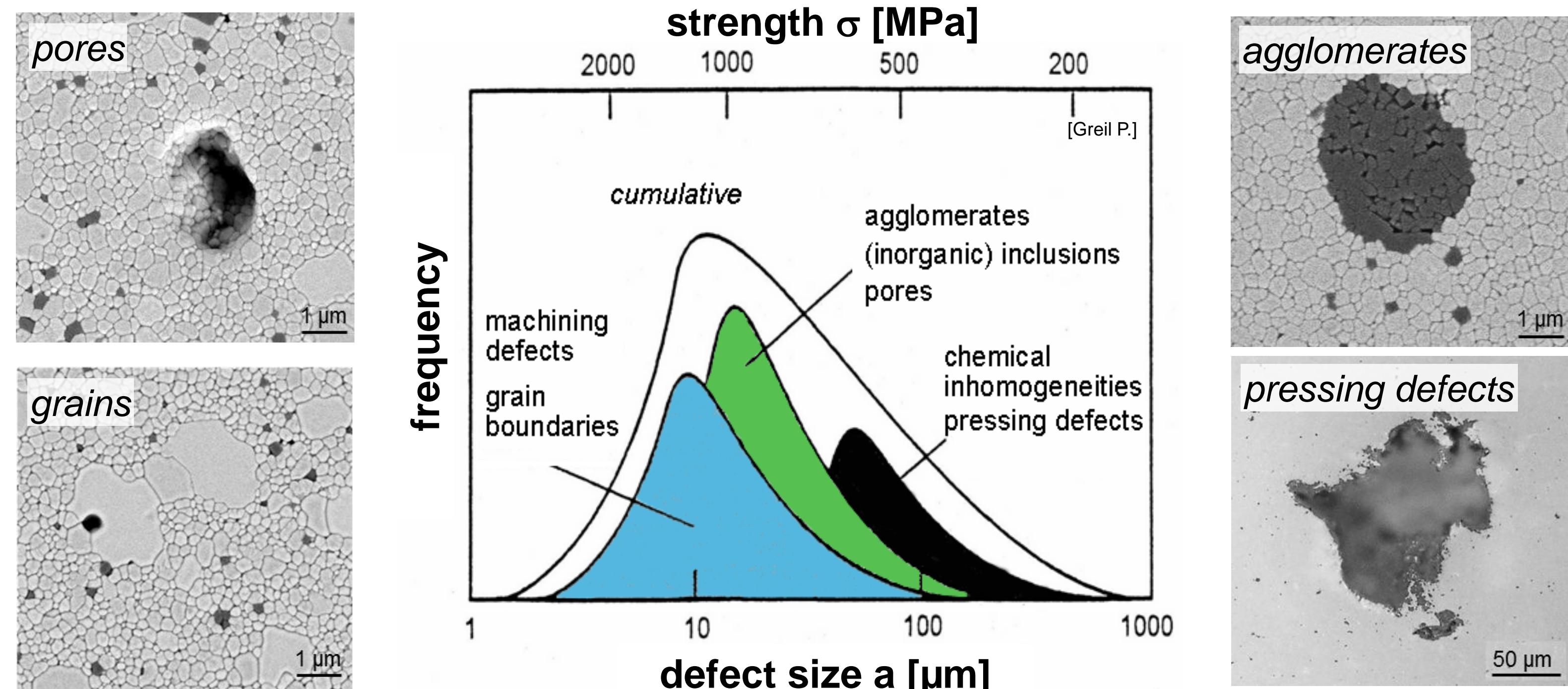
Determination of material properties (e.g. reliability, strength) of high-performance ceramic components



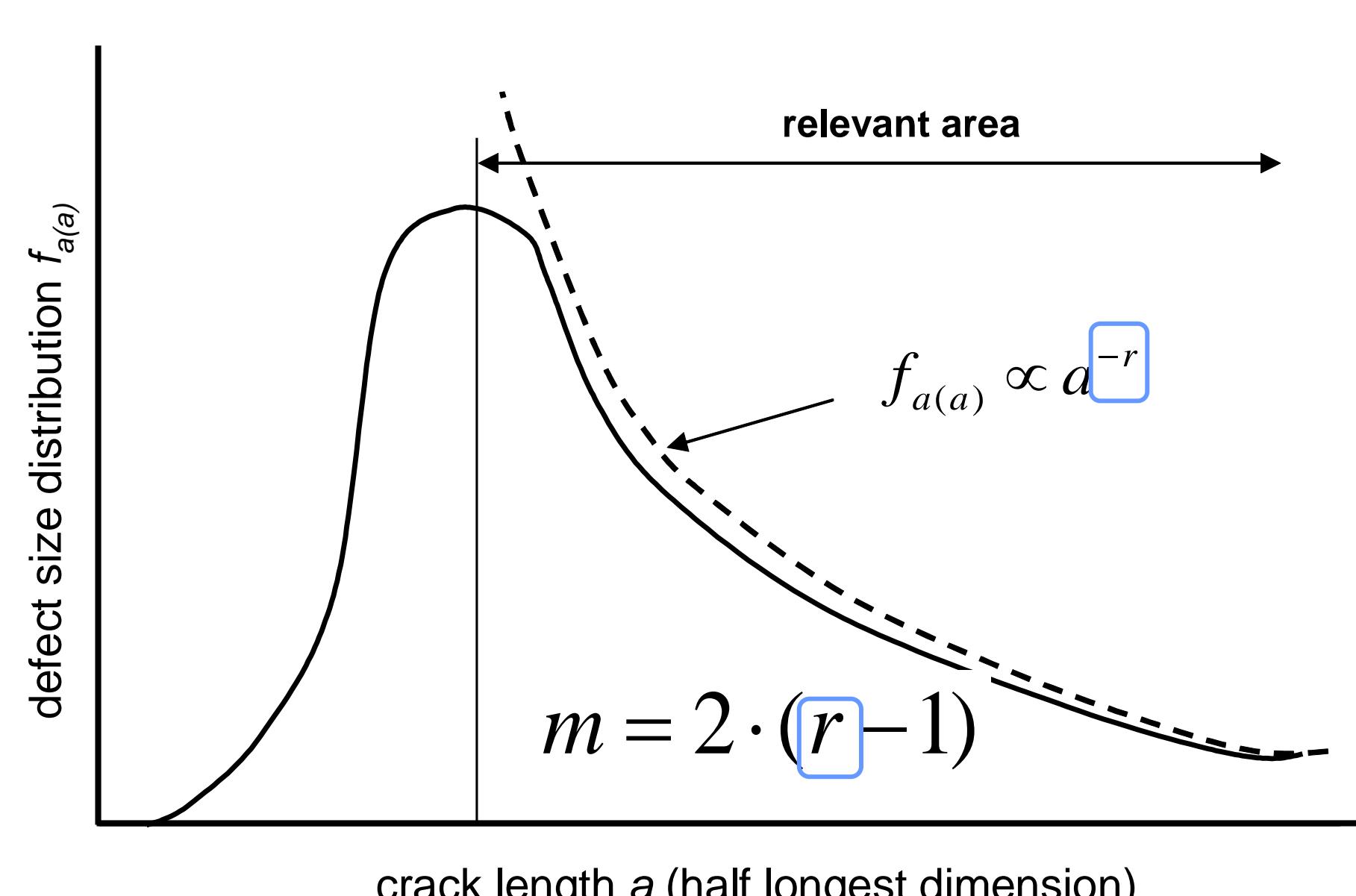
- localised analysis on real components
- consideration and visualisation of inhomogeneities and processing influences
- development of processing on real components and not on model samples

Problems of ceramics and theoretical background

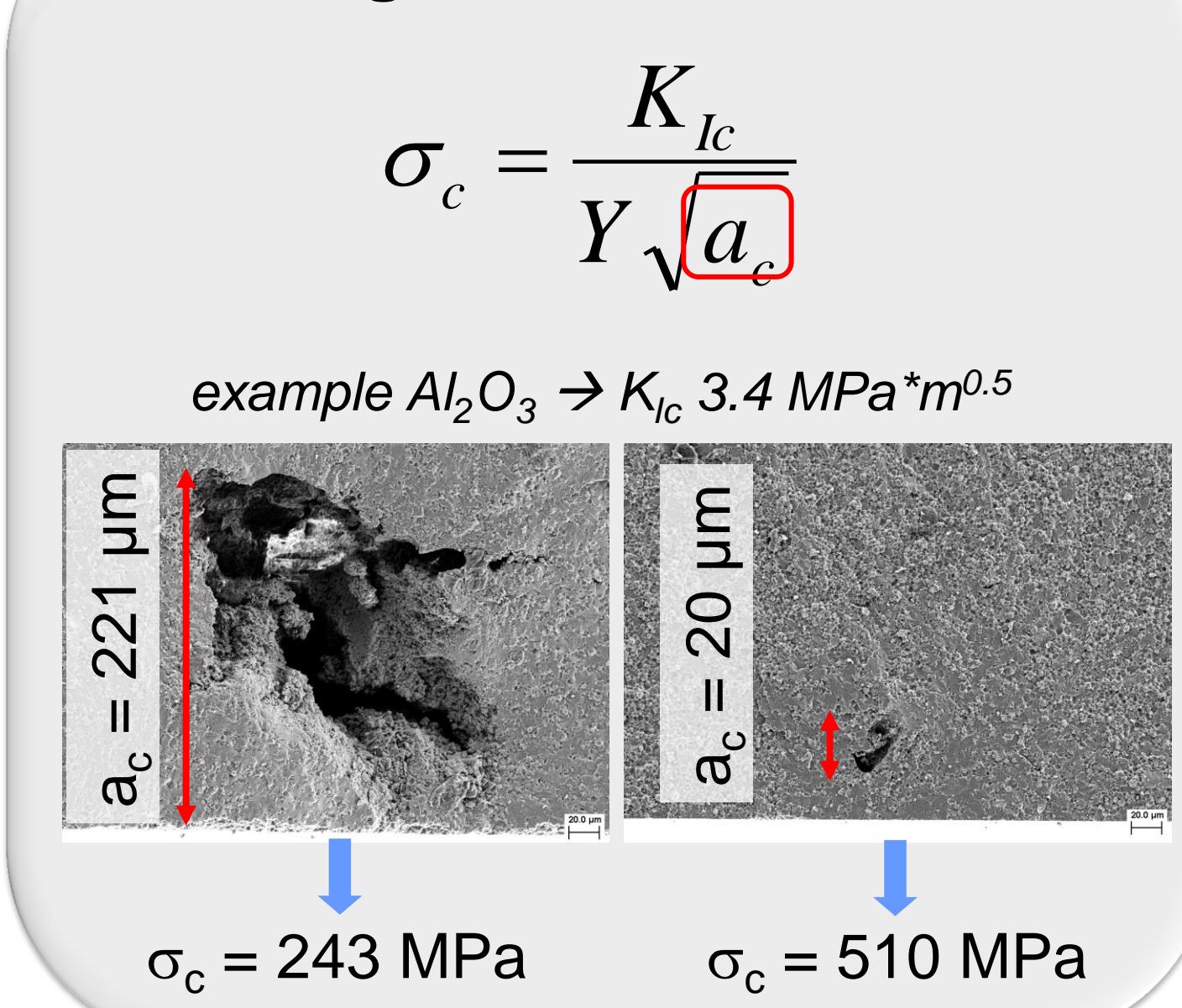
- brittleness → significant lower toughness (K_{Ic}) compared to metals/polymers
- reliability → strong scattering of strength (Weibull modulus m) due to various defect characteristics and defect sizes



Weibull modulus m – defect size distribution

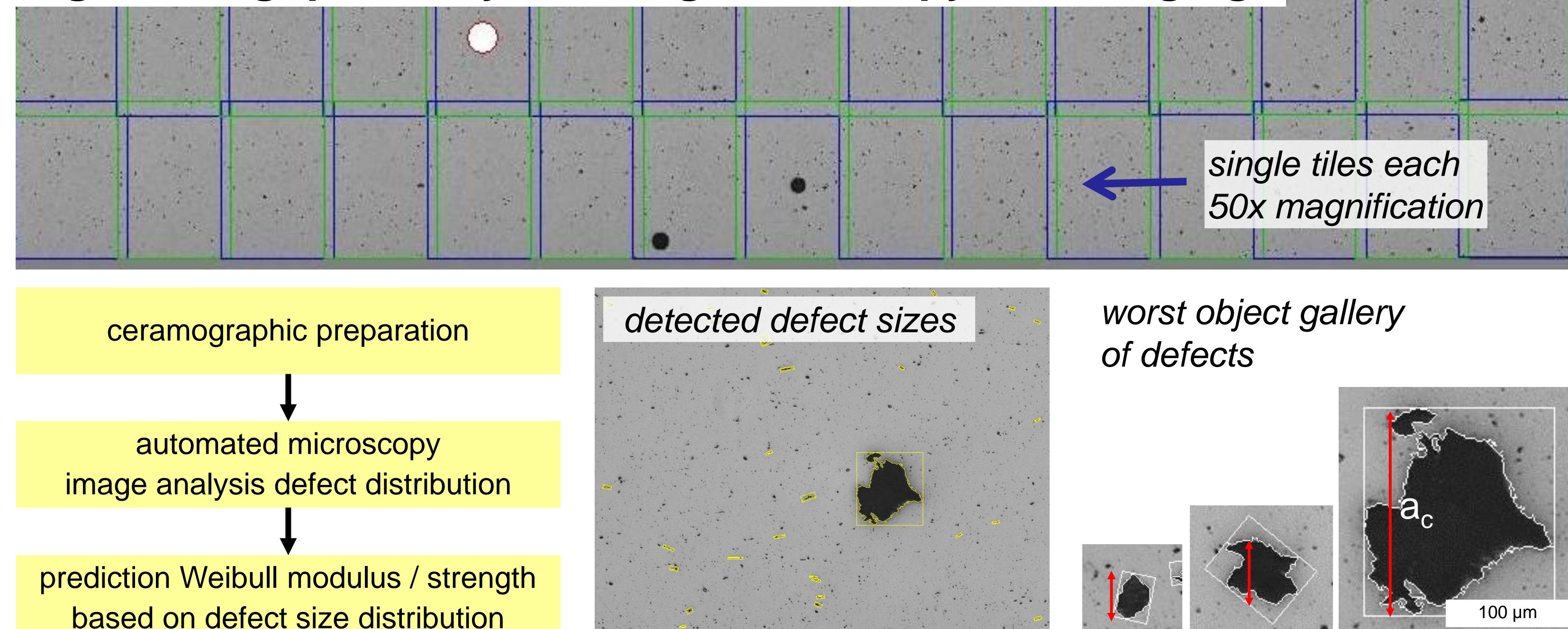


strength σ – defect size a



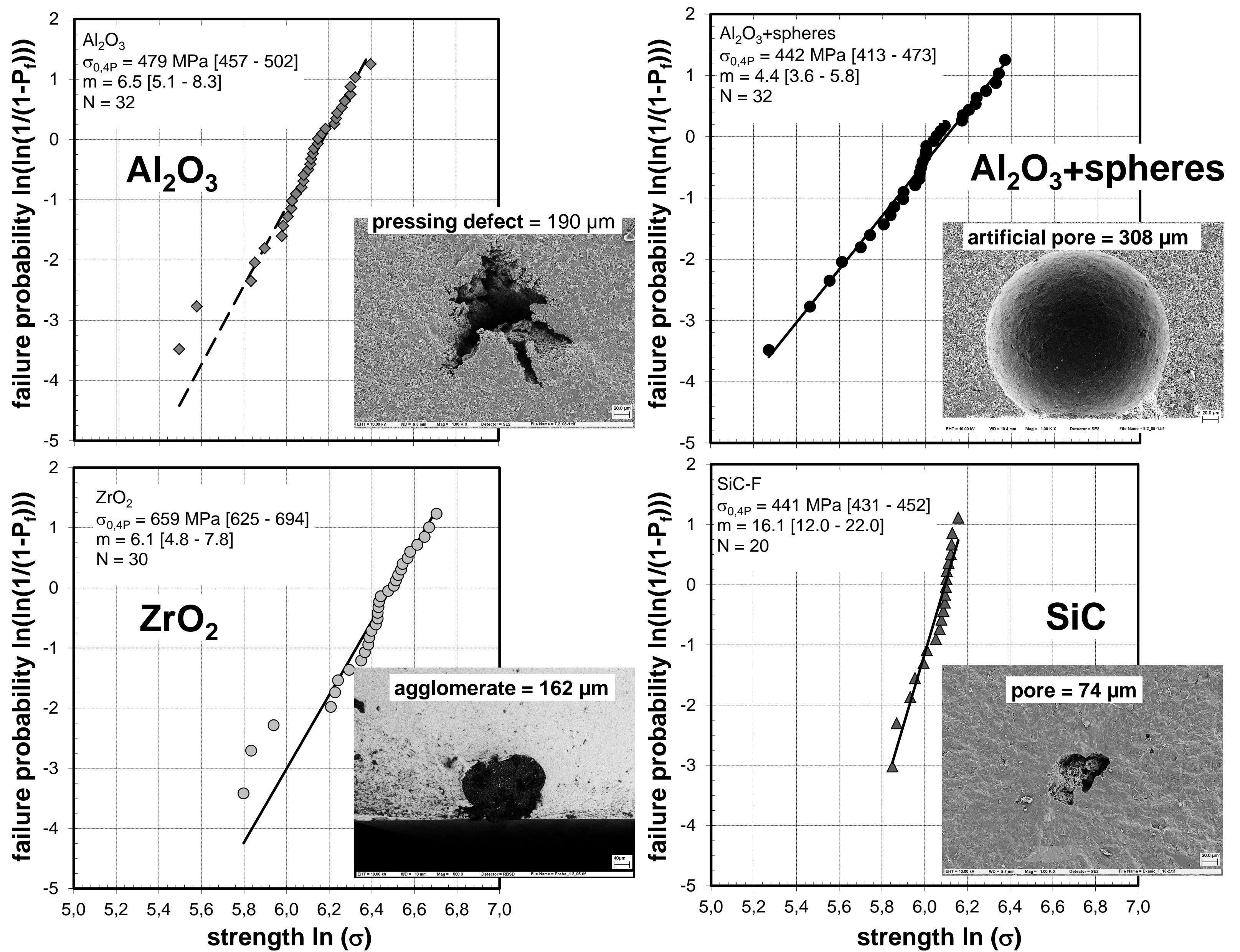
Approach

High-throughput analysis using microscopy and imaging

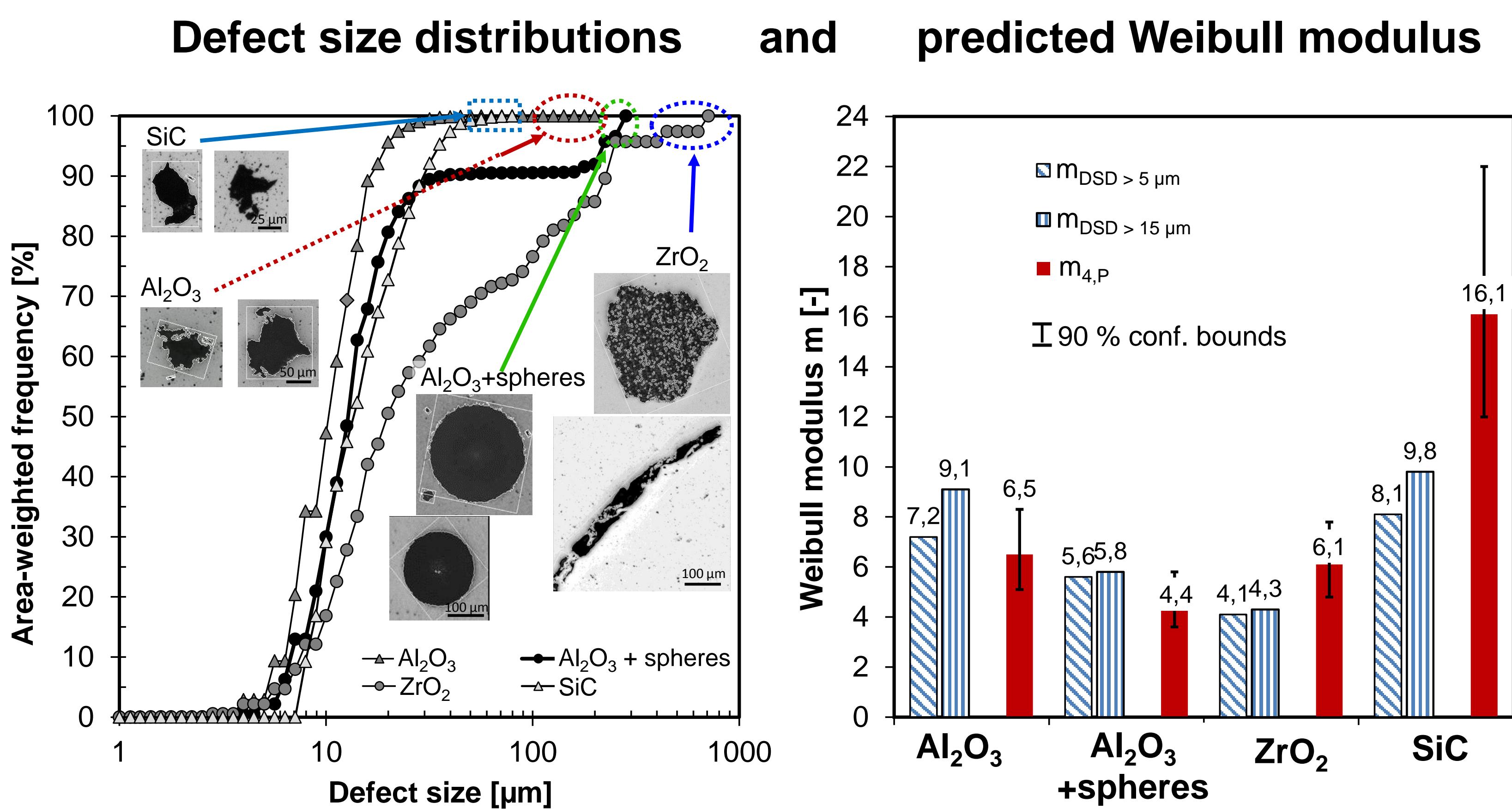


Results

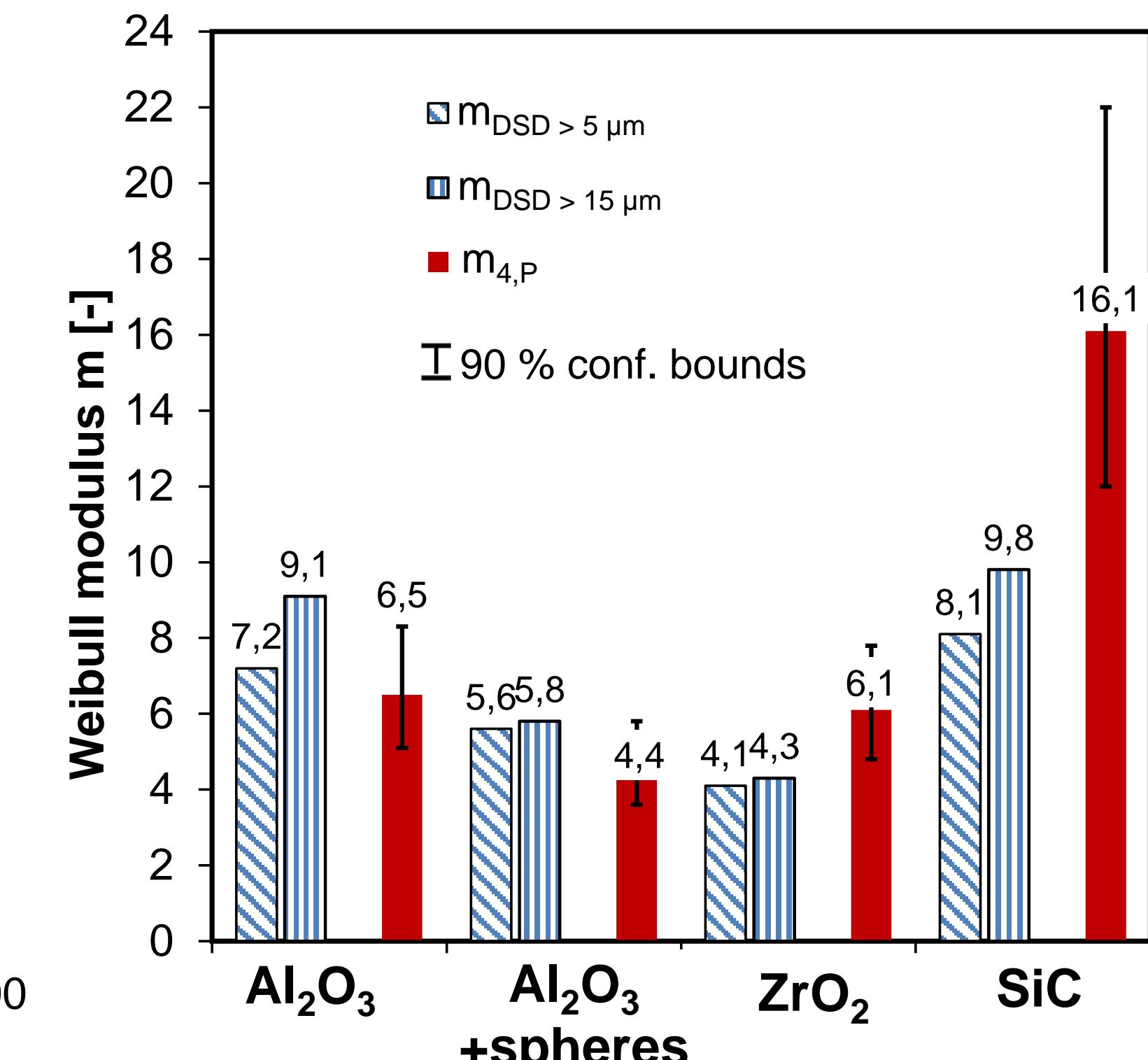
Four-point bending strength distributions of investigated ceramics



Defect size distributions

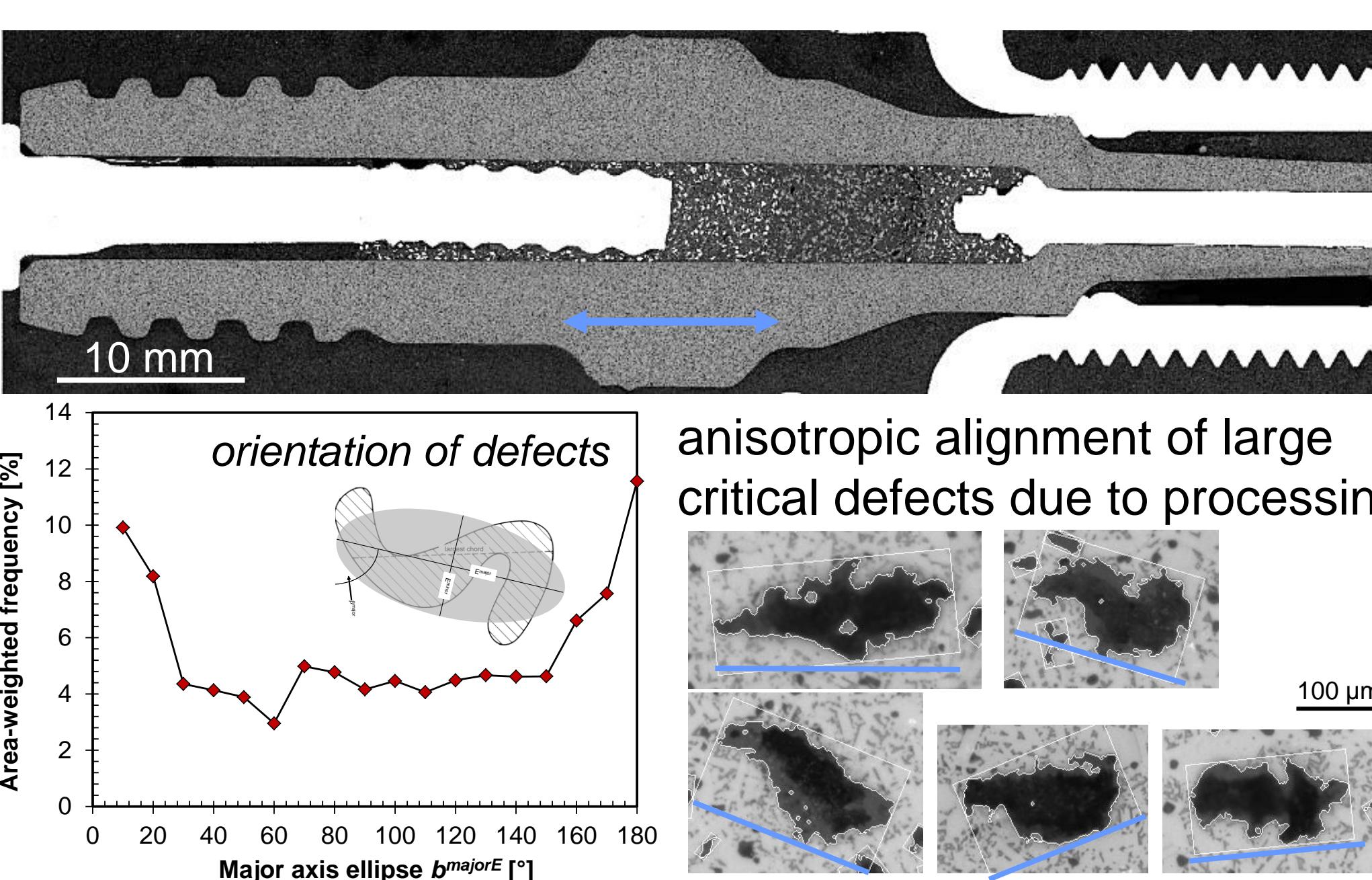


and predicted Weibull modulus



Outlook and potential of technique

Microstructural analysis of Al_2O_3 -isolation body spark plug



Issues

- processing influence → powder preparation → cold isostatic pressing
- anisotropic behaviour of defects due to processing
- reliability
 - electrical break down
 - strength
- general increased quality

Conclusions

- ceramography delivers almost identical defect characteristics compared to mechanical testing & fractography
- prediction of Weibull modulus shows close accordance proposed method allows to determine the scattering of strength data
- Processing, which often determines the defect characteristics and thus is responsible for the scattering can be optimized applying this advantageous method
- promising technique to characterize and improve high-performance ceramic components, e.g. spark plugs, sensors